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Functional Differences Between Masks 3F48S and 1K30A of the DSP56301

This document describes the differences between masks of the DSP56301: mask 1K30A and the preceding mask 3F48S. The newer 1K30A mask uses the communications design rules (CDRII) process. The 1K30A mask set also has new I/O and a new PLL, with the requisite change in the PLL capacitor equation (PCAP).

1 1K30A Mask Set

The 1K30A mask set replaced the 3F48S mask set in production.

2 PLL Input Capacitor (C_{PCAP})

The process change results in a changed requirement for computing the size of C_{PCAP} the capacitor used with the PCAP input. **Table 1** lists the new formulas for computing the value of this input capacitor for the DSP.

3 ESD Protection

The 1K30A mask set incorporates improved I/O structures to ensure Electro-Static Discharge (ESD) protection to qualification levels of 2000 volts Human Body Model (HBM) and 200 volts Machine Model (MM).

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4 Differences Overview

The primary functional differences between the mask sets are due to inherent differences between the two design technologies. **Table 1** compares the mask sets.

Table 1. Functional Comparison of 3F48S and 1K30A

Footure	3F4	8S		1K30A					
Feature	Recommended	Min	Max	Recommended	Min	Max			
Technology	0.5 micron	_	_	Sub 0.4 micron	_	_			
PLL input capacitor (C _{PCAP})	Uses the following rules: For MF ≤4: C _{PCAP} = [(500 × MF) – 150] pF	(MF × 425) –	(MF × 590) –	Use the following rules: For MF ≤4: C _{PCAP} = [(680 × MF) – 120]	(MF × 580) –	(MF × 780) –			
	For MF > 4:	125	175	pF	100	140			
	$C_{PCAP} = (690 \times MF) pF$	MF × 520		For MF > 4: $C_{PCAP} = (1100 \times MF) pF$	MF × 830	MF × 1470			

5 Asynchronous Bus Arbitration

In the Operating Mode Register (OMR) of the 1K30A is a new Asynchronous Bus Arbitration (ABE) bit to support external access at high frequencies. As **Figure 1** shows, bit 13 in the OMR enables Asynchronous Bus Arbitration. For convenience, **Table 2** defines all the OMR bits available in the 1K30A mask set of the DSP56301. The new ABE bit is highlighted in a bold red font.

			S	CS							EO	М							CC	M			
23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			SEN	WRP	EOV	EUN	XYS	ATE	APD	ABE	BRT	TAS	BE	CDF	P1:0	MS	SD		EBD	MD	MC	MB	MA
									ATE	—Addı	ress T	race	Enab	le			MS	—Ме	emory	Swite	ch Mo	ode	
									APD	—Addı Priorit			tion				SD	—Sto	p De	lay			
								ABE—Async. Bus Arbitration Enable						EBD—External Bus Disable									
	SEN	—Sta	ack E	xtens	ion E	nable		BRT—Bus Release Timing						MD—Operating Mode D									
	WRP	—Ex Fla	tende ig	ed Sta	ick W	rap		TAS—TA Synchronize Select					MC—Operating Mode C										
	EOV		tende erflow					BE—Burst Mode Enable							MB	—Op	eratir	ig Mo	de B				
	EUN—Extended Stack Underflow Flag					CDP1—Core-DMA Priority 1							MA	—Op	eratir	ng Mo	de A						
	XYS		ack E	xtens	ion S	pace		(CDP0	—Core	e-DMA	A Prio	rity 0										
	— R	eser	ved bi	t; rea	d as	zero;	shou	d be	writte	n with	zero f	or fut	ure co	ompa	tibilit	у							

Figure 1. Operating Mode Register (OMR)

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 Table 2. Operating Mode Register (OMR) Bit Definitions

Bit Number	Bit Name	Reset Value	Description
23–21		0	Reserved. Set to 0 for future compatibility.
20	SEN	0	Stack Extension Enable Enables/disables the stack extension in data memory. If the SEN bit is set, the extension is enabled. Hardware reset clears this bit, so the default out of reset is a disabled stack extension.
19	WRP	0	Stack Extension Wrap Flag Set when copying from the on-chip hardware stack (System Stack Register file) to the stack extension memory begins. You can use this flag during the debugging phase of the software development to evaluate and increase the speed of software-implemented algorithms. The WRP flag is a <i>sticky bit</i> (that is, cleared only by hardware reset or by an explicit MOVE operation to the OMR).
18	EOV	0	Stack Extension Overflow Flag Set when a stack overflow occurs in Stack Extended mode. Extended stack overflow is recognized when a push operation is requested while SP = SZ (Stack Size register), and the Extended mode is enabled by the SEN bit. The EOV flag is a <i>sticky bit</i> (that is, cleared only by hardware reset or by an explicit MOVE operation to the OMR). The transition of the EOV flag from zero to one causes a Priority Level 3 (Non-maskable) stack error exception.
17	EUN	0	Stack Extension Underflow Flag Set when a stack underflow occurs in Extended Stack mode. Extended stack underflow is recognized when a pull operation is requested, SP = 0, and the SEN bit enables Extended mode. The EUN flag is a <i>sticky bit</i> (that is, cleared only by hardware reset or by an explicit MOVE operation to the OMR). Transition of the EUN flag from zero to one causes a Priority Level 3 (Non-maskable) stack error exception. NOTE: While the chip is in Extended Stack mode, the UF bit in the SP acts like a normal counter bit.
16	XYS	0	Stack Extension XY Select Determines whether the stack extension is mapped onto X or Y memory space. If the bit is clear, then the stack extension is mapped onto the X memory space. If the XYS bit is set, the stack extension is mapped to the Y memory space.
15	ATE	0	Address Trace Enable When set, the Address Trace Enable (ATE) bit enables Address Trace mode. The Address Trace mode is a debugging tool that reflects internal memory accesses at the external address lines.
14	APD	0	Address Attribution Priority Disable Disables the priority assigned to the Address Attribute signals (AA0-AA3). When APD = 0 (default setting), the four Address Attribute signals each have a certain priority: AA3 has the highest priority, AA0 has the lowest priority. Therefore, only one AA signal can be active at one time. This allows continuous partitioning of external memory; however, certain functions, such as using the AA signals as additional address lines, require the use of additional interface hardware. When APD is set, the priority mechanism is disabled, allowing more than one AA signal to be active simultaneously. Therefore, the AA signals can be used as additional address lines without the need for additional interface hardware.
13	ABE	0	Asynchronous Bus Arbitration Enable Eliminates the setup and hold time requirements (with respect to CLKOUT) for \overline{BB} and \overline{BG} , and substitutes a required non-overlap interval between the deassertion of one \overline{BG} input to a DSP56300 family device and the assertion of a second BG input to a second DSP56300 family device on the same bus. When the ABE bit is set, the \overline{BG} and \overline{BB} inputs are synchronized. This synchronization causes a delay between a change in \overline{BG} or \overline{BB} until this change is actually accepted by the receiving device.

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chronous Bus Arbitration

 Table 2. Operating Mode Register (OMR) Bit Definitions (Continued)

Bit Number	Bit Name	Reset Value	Description
12	BRT	0	Bus Release Timing Selects between fast or slow bus release. If BRT is cleared, a Fast Bus Release mode is selected (that is, no additional cycles are added to the access and BB is not guaranteed to be the last Port A pin that is tri-stated at the end of the access). If BRT is set, a Slow Bus Release mode is selected (that is, an additional cycle is added to the access, and BB is the last Port A pin that is tri-stated at the end of the access).
11	TAS		TA Synchronize Select Selects the synchronization method for the input Port A pin— \overline{TA} (Transfer Acknowledge). If TAS is cleared, you are responsible for asserting the \overline{TA} pin in synchrony with the chip clock, as described in the technical data sheet. If TAS is set, the \overline{TA} input pin is synchronized inside the chip, thus eliminating the need for an off-chip synchronizer. Note that the TAS bit has no effect when the \overline{TA} pin is deasserted: you are responsible for deasserting the \overline{TA} pin in synchrony with the chip clock, regardless of the value of TAS.
10	BE	0	Cache Burst Mode Enable Enables/disables Burst mode in the memory expansion port during an instruction cache miss. If the bit is cleared, Burst mode is disabled and only one program word is fetched from the external memory when an instruction cache miss condition is detected. If the bit is set, Burst mode is enabled, and up to four program words are fetched from the external memory when an instruction cache miss is detected.
			Core-DMA Priority Specify the priority of core and DMA accesses to the external bus. 00 Determined by comparing status register CP[1:0] to the active DMA channel
9–8	CPD	1	priority 01 DMA accesses have higher priority than core accesses 10 DMA accesses have the same priority as the core accesses 11 DMA accesses have lower priority than the core accesses
7	MS	0	Memory Switch Mode Allows some internal data memory (X, Y, or both) to become part of the chip internal Program RAM.
			 Program data placed in the Program RAM/Instruction Cache area changes its placement after the MS bit is set (that is, the Instruction Cache always uses the highest internal Program RAM addresses). To ensure proper operation, place six NOP instructions after the instruction that changes the MS bit. To ensure proper operation, do not set the MS bit while the Instruction Cache is enabled (CE bit is set in SR).
6	SD	0	Stop Delay Mode Determines the length of the delay invoked when the core exits the Stop state. The STOP instruction suspends core processing indefinitely until a defined event occurs to restart it. If SD is cleared, a 128K clock cycle delay is invoked before a STOP instruction cycle continues. However, if SD, the delay before the instruction cycle continues is 16 clock cycles. The long delay allows a clock stabilization period for the internal clock to begin oscillating and to stabilize. When a stable external clock is used, the shorter delay allows faster start-up of the DSP56300 core.
5		0	Reserved. Set to 0 for future compatibility.
4	EBD	0	External Bus Disable Disables the external bus controller to reduce power consumption when external memories are not used. When EBD is set, the external bus controller is disabled and external memory cannot be accessed. When EBD is cleared, the external bus controller is enabled and external access can be performed. Hardware reset clears the EBD bit.

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Table 2. Operating Mode Register (OMR) Bit Definitions (Continued)

Bit	Bit	Reset	Description
Number	Name	Value	
3–0	MD-MA		Chip Operating Mode Indicate the operating mode of the DSP56300 core. On hardware reset, these bits are loaded from the external mode select pins, MODD, MODC, MODB, and MODA, respectively. After the DSP56300 core leaves the Reset state, MD, MC, MB, and MA can be changed under program control.

6 Boot Mode Changes

The 1K30A mask set of the DSP56301 modifies the boot modes of the microprocessor in order to add the ability to boot from a serial EPROM (see **Table 3**). Adding this new booting capability requires that MODD no longer be a "don't care." The MODD column of **Table 3** shows the correct MODD setting for each boot mode. These settings are communicated to customers in Product Change Notice (PCN) No. 4302. Changes in boot mode that occur with 1K30A appear in bold red font.

Table 3. New DSP56301 Boot Modes for CDR2

Boot Mode	MODD	3F48S	1K30A
0	0	expanded mode	expanded mode
1	0	bootstrap from byte-wide memory	reserved
2	0	bootstrap through SCI	bootstrap through SCI
3	0	reserved	reserved (burn-in)
4	0	host bootstrap PCI mode (32 bit wide)	bootstrap from serial EEPROM
5	0	host bootstrap 16-bit wide UB mode (ISA)	reserved
6	0	host bootstrap 8-bit wide UB mode in double- strobe pin configuration	host bootstrap 8-bit wide UB mode in double-strobe pin configuration
7	0	host bootstrap 8-bit wide UB mode in single-strobe pin configuration	reserved
8	1	expanded mode	expanded mode
9	1	bootstrap from byte-wide memory	bootstrap from byte-wide memory
А	1	bootstrap through SCI	bootstrap through SCI
В	1	host bootstrap in onyx-to-onyx mode	host bootstrap in onyx-to-onyx mode
С	1	host bootstrap PCI mode (32-bit wide)	host bootstrap PCI mode (32 bit wide)
D	1	host bootstrap 16-bit wide UB mode (ISA)	host bootstrap 16-bit wide UB mode (ISA)
Е	1	host bootstrap 8-bit wide UB mode in double- strobe pin configuration	host bootstrap 8-bit wide UB mode in double-strobe pin configuration

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Table 3. New DSP56301 Boot Modes for CDR2

Boot Mode	MODD	3F48S	1K30A
F	1	host bootstrap 8-bit wide UB mode in single-strobe pin configuration	host bootstrap 8-bit wide UB mode in single-strobe pin configuration

7 Identification Registers

Values in the Device Identification register (IDR) and JTAG Identification (ID) register are changed to reflect the new 1K30A mask set, as shown in **Figure 2** and **Figure 3**.

The IDR is a 24-bit, read-only factory-programmed register that identifies DSP56300 family members. It specifies the derivative number and revision number of the device. This information is used in testing or by software. **Figure 2** shows the contents of the IDR for mask set 1K30A. Revision numbers are assigned as follows: \$0 is revision 0, \$1 is revision A, and so on.

23		16	15		12	11		0
	Reserved		Revisi	ion Numb	er		Derivative Number	
	0000 0000			0011			0011 0000 0001	

Figure 2. Identification Register Configuration (Revision 3)

The JTAG ID register is a 32-bit read-only factory-programmed register that distinguishes the component on a board according to the IEEE 1149.1 standard. **Figure 3** shows the JTAG ID register configuration for mask set 1K30A. Version information corresponds to the revision number (\$0 for revision 0, \$1 for revision A, etc.).

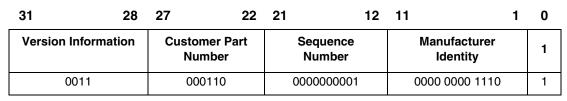


Figure 3. JTAG Identification Register Configuration (Revision 3)

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8 Errata Removal

The 1K30A mask set removes all known functional errata on the 3F48S mask set. This section shows the functional errata that the 1K30A mask set removes. For further documentation updates, consult the errata for each device. The specific differences in errata items are listed in the following tables. A detailed description of each errata item is available at the Freescale website listed on the back page of this document. The silicon errata present on the 3F48S mask but not on the 1K30A masks are listed as follows:

Errata No.	Description	Status
ES16	Description: When the chip is powered up with PLL enabled (PINIT = 1), the skew between EXTAL and CLKOUT after the PLL locks cannot be guaranteed at high frequency (over 50 MHz, not 100% tested). Workaround: If skew between EXTAL and CLKOUT is needed, power up with PINIT = 0, and then enable the PLL by software.	Fixed on 1K30A
ES30	Description: After the BB pin output is driven high and released, the pin output voltage level may not reach V _{CC} . The issue depends on the application board layout and the parameters of the chip process. Workaround: Use a restricted board layout that includes a 1 kΩ pull-up resistor connected to the BB pin with a 100 Ω resistor connected in series with, and as close as possible to, the pin. The board route from the BB pin to any component should guarantee the following parameters: • Route inductance < 40 nH • Route capacitance < 15 pF • Input capacitance < 8 pF Such restrictions guarantee that when BB is driven high (deasserted), the output voltage level will be above 2.25 V at V _{CC} = 3.3 V.	Fixed on 1K30A
ES36	Description: If the stack extension is enabled, the instructions listed below should not be placed as the next-to-last or as the last instruction of a DO loop (that is, should not appear at LA-1 or LA). The instructions are: • XY Memory Data Move (A-6.76) X Memory Move (A-6.71) Y Memory Move (A-6.73) Long Memory Data Move (A-6.75) Immediate Short Data Move (A-6.68) Register to Register Data Move (A-6.69) Address Register Update (A-6.70) X Memory and Register Data Move (A-6.72) Y Memory and Register Data Move (A-6.74) Arithmetic Instructions that allow Parallel Moves listed above IFcc and IFcc.U (A-6.41) Workaround: Insert a NOP or other instruction not listed above as the next-to-last and last instructions in the DO loop.	Fixed on 1K30A
ES37	Description: In PCI mode, improper HI32 operation may result if the HTXR/HRXS registers are accessed by the PCI master at byte address Base_Address + (N × 2048 + 16), where N is an integer from 1–31. Workaround: Not available.	Fixed on 1K30A
ES41	Description: The HCLK pin of the HI32 presents an input capacitive load of almost 30 pF, which exceeds the permissible maximum load of 12 pF as specified in the PCI Specification Version 2.1. This may cause improper HI32 operation in PCI systems. The effect of this extra load may vary from system to system, depending on PCI clock driver strength. Workaround: Use a zero-propagation-delay external PLL device (e.g., CY2305) to buffer the PCI clock signal. This solution does not enable spread-spectrum PCI clocking.	Fixed on 1K30A



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Errata No.	Description	Status
ES42	Description: When a Direct Memory Access (DMA) channel is in Line mode (that is, the DMA Transfer Mode is DTM = 010) with address modes defined by DMA Three Dimensional mode D3D = 0 and DMA = 10010x (that is, the DMA Counter (DCO) is in mode A), and the DCO value is greater than \$FFF, then the DMA does not function properly. This address mode implies "no update" at the destination and "no update" or "post increment by 1" mode at the source. Workaround: Use Block Transfer mode (that is, DTM = 000). For the DCO and DMA Address Mode (DAM) settings described in this erratum, the Line Transfer mode of DMA is identical to its Block Transfer mode, so this combination is redundant. In fact, a block containing only one line is still a block.	Fixed on 1K30A
ES44	Description: Let's say that "channel A" is the DMA channel servicing the HI32, and that "channel B" is another DMA channel that has been disabled by software. Then, depending on the DMA Request Source field (DRS[4:0]) of the two channels, channel A may be stalled by channel B being disabled. Channel A may be stalled when the DMA Channel Enable (DE) bit in the DMA Control Register is cleared by software in the following cases: • DE bit of channel B cleared by software because of —a Transfer Done from DMA channel 0 (DRSb = 00100) or —an ESSI1 Receive Data (DRSb = 01100) or then channel A may be stalled by a Host Slave Receive Data (DRSa = 11100). • DE bit of channel B cleared by software because of —a Transfer Done from DMA channel 1 (DRSb = 00101) or —an ESSI1 Transmit Data (DRSb = 01101) or then channel A may be stalled by a Host Master Receive Data (DRSa = 11101). • DE bit of channel B cleared by software because of —a Transfer Done from DMA channel 2 (DRSb = 00110) or —an SCI Receive Data (DRSb = 01110) or then channel A may be stalled by a Host Slave Transmit Data (DRSa = 11110). • DE bit of channel B cleared by software because of — a Transfer Done from DMA channel 3 (DRSb = 00111) or — an SCI Transmit Data (DRSb = 01111) or then channel A may be stalled by a Host Master Transmit Data (DRSa = 11111). Workaround: Use either one of the following alternatives: • Clear and set the DE bit of channel A immediately after you clear the DE bit of channel B. • Avoid a software clear of the DE bit of channel B.	Fixed on 1K30A
ES45	Description: When the Host Command Vector Register (HCVR) is written in Peripheral Component Interconnect (PCI) mode while the Receive Buffer Lock Enable (RBLE) bit is set in the DSP PCI Control Register (DPCR), the Host Data Transfer Complete (HDTC) status bit in DSP PCI Status Register (DPSR) may be set falsely, thus also causing an HDTC interrupt if that interrupt has been enabled by the Transfer Complete Interrupt Enable (TCIE) bit in the DPCR. Workaround: Use either one of the following alternatives: Clear HDTC, if it is set, by writing it with 1 in the Host Command Interface Status Register (ISR). Clear HDTC, if it is set, by writing it with 1; use software-dependent information to distinguish between a false and true HDTC setting. For example, you do either of the following: —Alter the destination address pointer if the DSP Receive Data Register (DRXR) data is being transferred by the DSP core. The pointer is changed if the HDTC setting is true. —Alter the destination address or counter registers of the DMA channel if the DRXR data is being transferred by the DMA. The registers are changed if the HDTC setting is true.	Fixed on 1K30A
ES47	Description: If the DMA channel and the core access the same 1/4 K internal X data, Y data, or program memory page, and the DMA interrupt is enabled, a false interrupt may occur in addition to the correct one. Workaround: Ensure that the channel's DTD status bit in the DSTR is set before jumping to the Interrupt Service Routine (that is, the interrupt is correct only when DTD is set). Example: ORG P:I_DMA0 JSSET #M_DTD0,X:M_DSTR,ISR; ISR is the Interrupt Service; Routine label for DMA channel 0	Fixed on 1K30A

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Errata No.	Description	Status
ES53	Description: Using the JTAG instruction code 1111 (\$F) or 1101 (\$D) for the BYPASS instruction may cause the chip to enter Debug mode (which then correctly sets the Status bits (OS[1:0]) in the OnCE Status and Control Register (OSCR[7:6]) and asserts the DE output to acknowledge the Debug mode status). Workaround: Use one of the following alternatives: If possible, do not use instruction code 1111 (\$F) or 1101 (\$D) for the BYPASS instruction. Use one of the other defined BYPASS instruction codes (that is, any code from 1000−1100 (\$8−\$C) or 1110 (\$E)). If you must use instruction code 1111 (\$F) or 1101 (\$D), use the following procedure:	Fixed on 1K30A
	 —While the \$F or \$D instruction code is in the Instruction Register, ensure that the JTAG Test Access Port (TAP) state machine does not pass through the JTAG Test-Logic-Reset state while accessing any JTAG registers (that is, Instruction Register, Boundary Scan Register, or ID Register). —Before using any other JTAG instruction, load one of the other BYPASS instruction codes (that is, any code from 1000–1100 (\$8–\$C) or 1110 (\$E)) into the instruction register. Then, any other JTAG instruction may be used. 	
ES72	Description (added 10/30/1997): During external memory accesses, noise may be generated by the Bus Strobe (\$\overline{BS}\$) signal and placed on the Test Clock (TCK) signal, causing the JTAG Test Access Port (TAP) controller to change states unpredictably. This problem may be more severe at higher speeds or in applications using multiple DSP56300 families. Note: Applies to PBGA package only.	Fixed on 1K30A
	Workaround: Bypass the BS line to signal ground with a 10 pF capacitor.	
ES81	Description: The HI32 may generate a wrong PAR signal. Workaround:	Fixed on 1K30A
	If possible, the system should ignore parity errors generated in such a case.	
	Description: The BL pin may operate improperly when two consecutive manipulation instructions (bset/bclr/bchg) use external memory as the destination.	Fixed on 1K30A
ES82	Example of the sequence: bset #5,x:(r0) ;; r0 is a pointer on an external memory address bclr #7,x:(r3) ;; r3 is a pointer on an external memory address	
	Workaround :	
	Separate the consecutive bit manipulation instructions by any other instruction, as in the following example:	
	<pre>bclr #7,x:(r3) ;; r3 is a pointer on an external memory address nop</pre>	
	bset #5,x:(r0) ;; r0 is a pointer on an external memory address	



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Errata No.	Description	Status
	 Description: When software disables a DMA channel (by clearing the DE bit of the DCR), the DTD status bit of the channel may not be set if any of the following events occur: Software disables the DMA channel just before a conditional transfer stall (Described by App B-3.5.1,UM). Software disables the DMA channel at the end of the block transfer (that is, after the counter is loaded with its initial value and transfer of the last word of the block is completed). As a result, the Transfer Done interrupt might not be generated. 	Fixed on 1K30A
	Workaround: Avoid using the instruction sequence causing the conditional transfer stall (See DSP56300 UM, App B-3.5.1 for description) in fast interrupt service routines. Every time the DMA channel needs to be disabled by software, the following sequence must be used:	
ES84	bclr #DIE,x:M_DCR ; not needed if DIE is cleared bclr #DE,x:M_DCR ; instead of two instructions above, one 'movep' instruction may be used ; to clear DIE and DE bits	
	<pre>movep #DCR_Dummy_Value,x:M_DCR bclr #DE,x:M_DCR nop</pre>	
	Here, the DCR_Dummy_value is any value of the DCR register that complies with the following requirements: DE is set; DIE is set if Transfer Done interrupt request should be generated and cleared otherwise; DRS[4:0] bits must encode a reserved DMA request source (see the following list of reserved DRS values);	
	List of reserved DRS[4:0] values (per device): • DSP56302, DSP56309, DSP56303, DSP56304, DSP56362 — 10101-11111 • DSP56305 — 11011 • DSP56301 — 10011-11011 • DSP56307 — 10111-11111	
ES86	Description: If the HI32 performs a write transaction as a PCI master and the transaction is disconnected by the target, the value of the MTRQ status bit in the DPSR register may be wrong.	Fixed on 1K30A
E30U	Workaround: Do not use an MTRQ status bit-related interrupt or polling. (The related DMA functionality is not affected by this issue.)	
ES87	Description: When the HI32 is an active PCI target, it does not set the DPE bit in the CSTR register if an address parity error occurs.	Fixed on 1K30A
	Workaround: The Host can get information about the Address Parity status either by reading the SSE bit (in the CSTR) or by indirectly reading the (e.g. via Host Command) the APER bit in the DPSR register.	
	Description: If the SCI Receiver is programmed to work with a different serial clock than the SCI Transmitter so that either the Receiver or Transmitter is using the external serial clock and the other is using the internally-generated serial clock—RCM and TCM in the SCCR are programmed differently)—then the internal serial clock generator will not operate and the SCI portion (Receiver or Transmitter) clocked by the internal clock will be stuck.	Fixed on 1K30A
ES89	Workaround: Do not use SCI with the two SCI portions (Receiver and Transmitter) clocked by different serial clocks; use either both externally or both internally clocked. Or:	
	When using both portions of the SCI (Receiver & Transmitter), do not program different values on RCM and TCM in the SCCR.	

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Errata No.	Description	Status
ES90	 Description: A deadlock occurs during DMA transfers if all the following conditions exist: 1. DMA transfers data between internal memory and external memory through port A. 2. DMA and the core access the same internal 0.25K memory module. 3. The bus arbitration system is implemented in such way that the bus is granted to the DSP (BG is asserted) only after the DSP requests it (BR is asserted). The symptom is a deadlock on DMA activity, that is, a DMA transfer stops for no apparent reason. BR is not asserted when it should be asserted because of DMA. Workaround: One of the following: 1. Use intermediate internal memory on which there is no contention with the core. 2. Do not use bus arbitration (tie BG to the ground), or have an external arbiter that asserts BG even if BR is not asserted by the DSP. 3. Set the DSP core priority higher than the DMA (for Port A accesses), and do a periodic external access by 	Fixed on 1K30A
ES95	the core. The core access solves the deadlock. Description: If more than a single DMA channel is enabled while the DSP stays in the WAIT processing state, and triggering one of the DMA channels causes an exit from the WAIT state (See A-6.115, UM), triggering another DMA channel might cause improper DMA operation. Workaround: Assure that only a single DMA channel can be triggered during DSP WAIT state. If the application cannot guarantee this, other DMA channels should be disabled before the WAIT processing state is entered and then	Fixed on 1K30A
ES101	reenabled after WAIT state is exited. Description: If the reset mode is expanded mode (for example, mode 0 or mode 8 on the DSP5630x), A MOVE (not a PROGRAM FETCH) from internal P memory to any destination may not work properly. Workaround: After each reset (RESET) negation and before the first move from internal program memory, execute the following sequence: BSET #M_CE, sr NOP NOP NOP BCLR #M_CE, sr	Fixed on 1K30A
ES104	Description: An improper operation may occur when all the following conditions apply: The DMA channel is in a mode that does not automatically clear the DE bit at the end of the block (DTM[2:0] = 1xx in DCR). This channel is disabled by software (by clearing DE in DCR) while it is triggered for a new transfer. The previous operation is not yet completed. Workaround: The DMA channel should be disabled only when it is not triggered for a new transfer, that is, when the DACT bit in the DSTR register is cleared. To perform this operation most efficiently, all other DMA channels should be disabled.	Fixed on 1K30A
ES107	Description: The HDTC status bit (relevant only if the RBLE control bit is set) may not be set properly when both of the following conditions apply: • a) DSP software clears the HDTC bit while the PCI bus is parked on the HI32. • b) The PCI master read transaction is initiated by the HI32 while the bus is still parked on the HI32. Workaround: Use one of the following alternatives: • Avoid bus parking on the HI32. • Enter the Personal Software Reset (HM[2:0]=0) in HDTC ISR. • Poll the MRRQ and SRRQ status bits before the start of each master read transaction (e.g. in MARQ ISR). Start this transaction only when both MRRQ and SRRQ are cleared. The HDTC status bit should be cleared by the DSP software as defined in the specification.	Fixed on 1K30A

Functional Differences Between Masks 3F48S and 1K30A of the DSP56301, Rev. 3



a Removal

Errata No.		De	escription	Status
ES114	dimensional (D3D=	ay operate improperly when the and 1) and DAM[5:0] = 1xx 1 10 or	address mode of this channel is defined as three-DAM[5:0] = 01x1 10 (that is, triple counter mode is E).	Fixed on 1K30A
	Description (added When a DMA chans may not get set, an 1. There is anoth cleared by softwarend of the channetransfer - if chans 2. This channel (software at the echannel B line transfer - workaround: Avoid executing a I	d 4/19/99): nel (called channel A) is disabled d the DMA end of the block inter er channel (channel B) executing are at the end of the channel B w el B line transfer - if channel B is nel B is in Block transfer mode. A) is executing EXTERNAL acce nd of the channel B word transfer ansfer - if channel B is in Line tra	DMA channel should be disabled. This can be done as	Fixed on 1K30A
		the DMA channel needs to be c ialize an unused DMA chann	disabled by software, the following sequence must be used:	
	movep	#DSR_swflag, x:M_DSRC	;; here DSR_swflag is an ;; unused X, Y or P memory ;; location, should ;; be initialized to ;; \$800000 ;; M_DSRC - address of the ;; channel C DSR register.	
ES115	movep	#DDR_swflag, x:M_DDRC	<pre>;; DDR_swflag is an unused ;; X, Y or P memory ;; location, should be ;; initialized to \$000000 ;; M_DDRC - ;; address of the channel C ;; DDR register .</pre>	
	movep	#TR_LENGTH, x:M_DCOC	;; see below the definition ;; of the TR_LENGTH value, ;; M_DCOC - address ;; of the channel C DCO register	
	movep	#1f0240, x:M_DCRC	;; M_DCRB - address of the ;; channel C DCR register. ;; Set transfer mode - ;; block transfer, ;; triggered by ;; software highest ;; priority, continuous ;; mode on no-update ;; source and destination ;; address mode X memory ;; location for source ;; and destination (can be ;; chosen by	

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Errata No.	Description			Status
ES115 cont.	of the read DMA cycle and f cycle can be defined as the	#3, mr #23, x:M_DCRC #23,x:DDR_swflag,* #23, x:M_DCRA #M_DTDA, x:M_DSTR,* be defined as the maximum length on the length of the write DMA cylength of the PORTA external acceptate case as 2 DSP clock cycles.	;; mask all interrupts ;; enable DMA channel C ;; wait until DMA channel C ;; begin transfer ;; disable DMA channel A ;; polling DTD bit of the DMA ;; channel A, n of the external DMA transfer——from the length cle. The length of the external read/write DMA ess. The length of the internal read/write DMA The TR_LENGTH can be found as sum of the	Fixed on 1K30A

9 Documentation Errata

Following are errata items that have been designated as documentation errata that are specification changes for the entire DSP56300 family, including the DSP56301. They have been documented as specification changes in the DSP56301 User's Manual and Technical Data sheet.

Errata No.	Description	Status
	Description (revised 11/9/98): XY memory data move does not work properly if the X-memory move destination is internal I/O and the Y-memory move source is a register used as destination in the previous adjacent move from non Y-memory OR the Y-memory move destination is a register used as source in the next adjacent move to non Y-memory.	DSP563xx Documentation Update
ED1	Here are examples of the two cases (where x:(r1) is a peripheral): Example 1: move #\$12,y0 move x0,x:(r7) y0,y:(r3) (while x:(r7) is a peripheral). Example 2: mac x1,y0,a x1,x:(r1) + y:(r6) +,y0 move y0,y1 This is not a bug, but a documentation update. Any of the following alternatives can be used: • Separate these two consecutive moves by any other instruction. • Split XY Data Move to two moves.	
ED2	Description (added 10/09/1997): BL pin timings T198 and T199 in the Data Sheet are changed, improving the arbitration latency: T198 is 5 ns (max), T199 is 0 ns (min). This is not a bug, but a documentation update.	DSP563xx Documentation Update
ED3	Description (added 10/09/1997): A one-word conditional branch instruction at LA-1 is not allowed. This is not a bug, but a documentation update.	DSP563xx Documentation Update
ED4	Description (added 10/09/1997): The following instructions should not start at address LA: MOVE to/from Program space {MOVEM, MOVEP (only the P space options)} This is not a bug but a documentation update (Appendix B, DSP56300 Family Manual).	DSP563xx Documentation Update
ED6	Description (added 4/13/98): When the HIRQ pin is used in pulse mode (HIRH=0 in DCTR), the LT[7:0] value (in CLAT) should not be zero. This is not a bug but a documentation update.	DSP563xx Documentation Update

Functional Differences Between Masks 3F48S and 1K30A of the DSP56301, Rev. 3



mentation Errata

Errata No.	Description	Status
ED7	Description (added 1/27/98): When activity passes from one DMA channel to another and the DMA interface accesses external memory (which requires one or more wait states), the DACT and DCH status bits in the DMA Status Register (DSTR) may indicate improper activity status for DMA Channel 0 (DACT = 1 and DCH[2:0] = 000).	DSP563xx Documentation Update
	Workaround: None. Pertains to: DSP56300 Family Manual, Sections 8.1.6.3 and 8.1.6.4.	
ED8	Description (added 10/09/1997): The timing for HSAK is no longer qualified by the data strobe. The new timing numbers are: T318—HSAK assertion from HA0–HA10 and HAEN valid is 30.0 ns maximum. T319—HSAK assertion hold from HA0-HA10 and NAEN not valid is 2.0 ns minimum. This is not a bug, but a documentation update of a specification change.	DSP563xx Documentation Update
ED10	Description (added 5/13/98): The HI32 may operate improperly in PCI mode when the TWSD bit is set in the HCTR register. Workaround: Do not set the TWSD bit in the HCTR register; this bit is reserved. This is a documentation change.	DSP563xx Documentation Update
ED12	Description (added 5/13/98): When the HI32 is in PCI mode, the HTF control bits affect the address insertion (the IAE bit is set in the DPCR register) in the same way they affect the transferred data. Address as appears on the PCI bus: \$12345678 HTF[1:0] Inserted Address 00 \$005678, \$001234 01 \$345678 10 \$345678 11 \$123456 Workaround: This is a documentation update.	DSP563xx Documentation Update
ED13	Description (added 5/15/98): When the Hl32 is in PCI mode, the Insert Address Enable control bit (IAE=1) can be set only with the Receive Buffer Lock Enable control bit set (RBLE=1 in the DPCR register.)	DSP563xx Documentation Update
ED15	Description (added 7/21/98): The DRAM Control Register (DCR) should not be changed while refresh is enabled. If refresh is enabled only a write operation that disables refresh is allowed. Workaround: First disable refresh by clearing the BREN bit, than change other bits in the DCR register, and finally applies refresh by certified the BREN bit.	DSP563xx Documentation Update
ED17	enable refresh by setting the BREN bit. Description (added 9/28/98): In all DSP563xx technical datasheets, a note is to be added under "AC Electrical Characteristics" that although the minimum value for "Frequency of Extal" is 0MHz, the device AC test conditions are 15MHz and rated speed. Workaround:	DSP563xx Documentation Update
ED18	N/A Description (added 11/2/98): The PCI host must not change the values of the HBE[3:0] bits during PCI read transactions from the HI32 as a PCI target.	DSP563xx Documentation Update
ED19	Description (added 11/9/98): To guarantee the proper HI32 operation, the DMA should service the HI32 under the following restrictions: Two DMA channels should not service the DRXR FIFO if master and slave data is mixed there. The DMA data transfers should not be concurrent with the 56300 Core data transfers to/from the same HI32 data FIFO.	DSP563xx Documentation Update
ED20	Description (added 11/24/98): In the Technical Datasheet Voh-TTL should be listed at 2.4 Volts, not as: TTL = Vcc-0.4	DSP563xx Documentation Update
	Workaround: This is a documentation update.	

Functional Differences Between Masks 3F48S and 1K30A of the DSP56301, Rev. 3



Errata No.	Description	Status
ED21	Description (added 11/24/98): In the Technical Datasheet Iol should be listed as 1.6 mA, not as 3.0 mA. Workaround:	DSP563xx Documentation Update
ED24	This is a documentation update. Description (added 11/24/98): The technical datasheet supplies a maximum value for internal supply current in Normal, Wait, and Stop modes. These values will be removed because we will specify only a "Typical" current. Workaround: This is a documentation update.	DSP563xx Documentation Update
ED25	Description (added 12/16/98): Current definition: HDTC is set if SRRQ and MRRQ are cleared (that is, the host-to-DSP data path is emptied by DSP56300 core reads) under one of the following conditions: • a non-exclusive PCI write transaction to the HTXR terminates or completes • HLOCK is negated after the completion of an exclusive write access to the HTXR • the HI32 initiates a read transaction. The HI32 disconnects (retry or disconnect-C) forthcoming write accesses to the HTXR as long as HDTC is set. New definition: HDTC is set if SRRQ and MRRQ are cleared (that is, the host-to-DSP data path is emptied by DSP56300 Core reads) under one of the following conditions: • a non-exclusive PCI write transaction to the HTXR terminates or completes • HLOCK is negated after the completion of an exclusive write access to the HTXR. The HI32 disconnects (retry or disconnect-C) forthcoming write accesses to the HTXR as long as HDTC is set. Note: The HDTC bit is not set after a read transaction initiated by the HI32 as a PCI master. Workaround: NTR	DSP563xx Documentation Update
ED26	Description (added 1/6/99): The specification DMA Chapter is wrong. The sentence, "Due to the DSP56300 Core pipeline, after DE bit in DCRx is set, the corresponding DTDx bit in DSTR will be cleared only after two instruction cycles." should be replaced with: "Due to the DSP56300 Core pipeline, after DE bit in DCRx is set, the corresponding DTDx bit in DSTR will be cleared only after three instruction cycles."	DSP563xx Documentation Update
ED27	Description (added 1/12/99): The PBGA mechanical package drawing in the 56301 and 56305 data sheets is incorrect. The figure numbers of the incorrect drawings are Figure 3-6 for the 56301 and Figure 3-3 for the 56305. The only incorrect part is the bottom view above the label "VIEW M-M." This view erroneously shows the number of pins on the package to be 256, but the actual number of pins is 252. In the drawing, the four balls in the corners should not appear.	DSP563xx Documentation Update



mentation Errata

Errata No.	Description		Status	
	When two consecutive	LAs have a condi	as Documentation Errata 2/1/99): itional branch instruction at LA-1 of the internal loop, the part the following sequence may generate incorrect results:	DSP563xx Documentation Update
	NO DO NO	#4, LABEL2		
		CC _DEST	; conditional branch at LA-1 of internal	
ED28	NO LABEL2	P	; internal LA	
LD 20	NO LABEL1 NO		; external LA	
	NO _DEST NO NO RT	P P		
	Appendix B, Section	B-4.1.3.	and LABEL1. Pertains to DSP56300 Family Manual,	
ED29	When the ESSI transm (WL[2:0]) = 100, the ES	its data with the C SSI is designed to	d as a Documentation errata 2/1/99): CRA Word Length Control bits duplicate the last bit of the 24-bit transmission eight times to g the 24-bit word correctly, eight 0s are being shifted.	DSP563xx Documentation Update
	Workaround: None at this time. Perta	ains to the <i>User's</i>	Manual, Section 7.4.1.7, Table 7-2.	
	Description (added 9/When the ESSI transm	12/1997; identified its data in the On-	d as a Documentation errata 2/1/99): -Demand mode (that is, MOD = 1 in CRB and DC[4:0] = transmission does not work properly.	DSP563xx Documentation Update
ED30	Workaround: To ensure correct oper WL[2:0] = 100 32- Pertains to the User's I	bit Word-Length r		
ED21/	SC1 signals to be prog programmed by the Po	rammed as outpu rt Control Registe	al frame sync (that is, SCD2 = 1 in CRB) causes the SC2 and its. If however, the corresponding multiplexed pins are er (PCR) to be GPIOs, then the GPIO Port Direction Register auses the ESSI to use an external frame sync if GPI is	DSP563xx Documentation Update
ED31/ ES40	This errata and workar	ound apply to both	h ESSI0 and ESSI1.	
	Workaround: To assure correct oper	ation oither progr	am the GPIO pins as outputs or configure the pins in the PCR	
	as ESSI signals.	ation, either progra		



Errata No.	Description	Status
ED32/	Description (added 11/9/98): When returning from a long interrupt (by RTI instruction), and the first instruction after the RTI is a move to a DALU register (A, B, X, Y), the move may not be correct, if the 16-bit arithmetic mode bit (bit 17 of SR) is changed due to the restoring of SR after RTI.	DSP563xx Documentation Update
ES103	Workaround:	
ES103	Replace the RTI with the following sequence:	
	movec ssl,sr	
	nop	
	rti	202
	Description (added 12/16/98): When Stack Extension mode is enabled, a use of the instructions BRKcc or ENDDO inside do loops might cause an improper operation. If the loop is non nested and has no nested loop inside it, the erratais relevant only if LA or LC values are being used outside the loop.	DSP563xx Documentation Update
	Workaround: If Stack Extension is used, emulate the BRKcc or ENDDO as in the following examples. We split between two cases, finite loops and do forever loops.	
	1) Finite DO loops (that is,not DO FOREVER loops) ===================================	
	Original code:	
	do #N,label1	
	do #M,1abel2	
ED33/	BRKcc	
ES109		
ES107	1-h-12	
	label2	
	label1	
	Will be replaced by:	
	do #N, label1	
	•••••	
	do #M label?	
	do #M, label2	
	do #M, label2 	
	Jcc fix_brk_routine	
	Jcc fix_brk_routine	
	Jcc fix_brk_routine	
	Jcc fix_brk_routine nop_before_label2	
	Jcc fix_brk_routine nop_before_label2 nop ; This instruction must be NOP.	



montation Errot

Errata No.	Description	Status
	label1	DSP563xx
	••••	Documentation Update
	••••	
	fix_brk_routine	
	move #1,1c	
	jmp nop_before_label2	
	ENDDO	
	Original code:	
	do #M,label1	
	••••	
	do #N,label2	
	•••••	
	••••	
	ENDDO	
	•••••	
	label2	
	•••••	
	label1	
ED33/	Will be replaced by:	
ES109	do #M, label1	
	••••	
cont.		
	do #N, label2	
	•••••	
	JMP fix_enddo_routine	
	nop_after_jmp	
	NOP ; This instruction must be NOP.	

	label2	

	 labal1	
	label1	
	fix_enddo_routine	
	move #1,1c	
	<pre>move #nop_after_jmp,la</pre>	
	jmp nop_after_jmp	
	2) DO FOREVER loops	
	BRKcc	
		1



Errata No.	Description	Status
	Original code:	DSP563xx
	do #M, label1	Documentaiton Update
	do forever,label2	
	BRKcc	
	1.1.10	
	label2	
	label1	
	Will be replaced by:	
	do #M, label1	
	do forever,label2	
	••••	
CD 44	JScc fix_brk_forever_routine ; <	
ED33/	Note: JScc and not Jcc	
ES109	••••	
cont.	nop_before_label2	
COIIL	nop_berore_raber2 nop ; This instruction must be NOP.	
	label2	
	••••	
	label1	
	••••	
	fix_brk_forever_routine	
	move ssh,x:<> ; <> is some reserved not used	
	address (for temporary data)	
	move #nop_before_label2,ssh	
	bclr #16,ssl ; move #1,lc	
	rti ; < note: "rti" and not "rts" !	
	ENDDO	
	Original code:	
	do #M, label1	



montation Errata

Errata No.	Description	Status
ED33/ ES109 cont.	do forever, label2 ENDDO label2 label1 Will be replaced by: do #M, label1 do forever, label2 JSR fix_enddo_routine ; < note: JSR and not JMP ; nop_after_jmp NOP ; This instruction should be NOP label2 label1	DSP563xx Documentation Update
ED34/ ES110	move #nop_after_jmp, la	DSP563xx Documentation Update

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Errata No.	Description	Status
	Description (added 4/19/99):	DSP563xx
ED37	In paragraph 6.1.1.11 on page 6-12 of the 301 User's Manual, there is an error, as follows: "HIRQ_ is asserted by the HI32 when a host interrupt request (recieve and/or transmit) is generated in the HI32"	Documentation Update
	Workaround/correction:	
	Should be: "HIRQ_ is asserted by the HI32 when a host interrupt request (receive and/or transmit) is generated in the HI32 (as described in paragraphs 6.2.1.1, 6.2.1.1 and 6.2.1.4)."	

10 Errata Deletion

The following documentation change should be omitted from the DSP56301 because it pertains to HI08, which does not exist on the DSP56301. This item was incorrectly documented as a DSP56301 errata.

Errata No.	Description	Status		
	The data sheets of the various DSP56300 host interfaces (HI32 excl the HI08/HDI08 compatible with PortA timing 114, which is included Timing 321 "Write data strobe deassertion width" should be split (sin strobe deassertion width"), as described here: Write data strobe deassertion width:	DELETION: Does Not Apply to Any Mask of the DSP56301		
	after HCTR, HCVR and "Last Data Register" writes	2.5*Tc+10.0 2.5*Tc+8.3 2.5*Tc+6.6	@66MHz @80MHz @100MHz	
ED14	after TXH:TXM writes (with HBE=0), TXM:TXL writes (with HBE=1)	25 20.6	@66MHz @80MHz	
	That is, a minimum of 4 WS for PortA is required for 100 MHz operat Reference: Timing 114 @ 100MHz WR_ deassertion time	16.5 tion.	@100MHz	
	0.5 x TC - 3.5 [WS = 1] TC - 3.5 [2 <= WS <= 3]	6.5ns		
	2.5 x TC - 3.5 [4 <= WS <= 7] 3.5 x TC - 3.5 [WS >= 8]	21.5ns		

a Deletion



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